

#### 核数据重点实验室

# The Progress of GEM foil at CIAE

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#### **Outline**

The progress of GEM foil at CIAE

Other developments





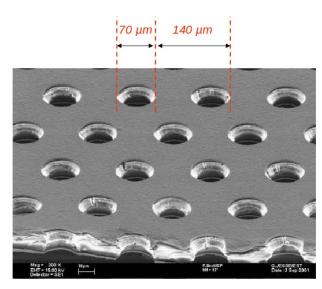
# The Progress of GEM Foil at CIAE



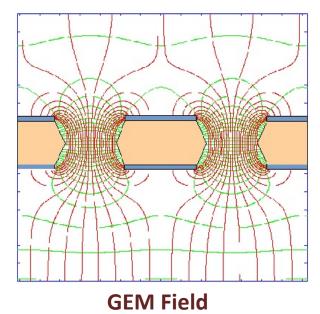


#### **GEM Foil Structure**

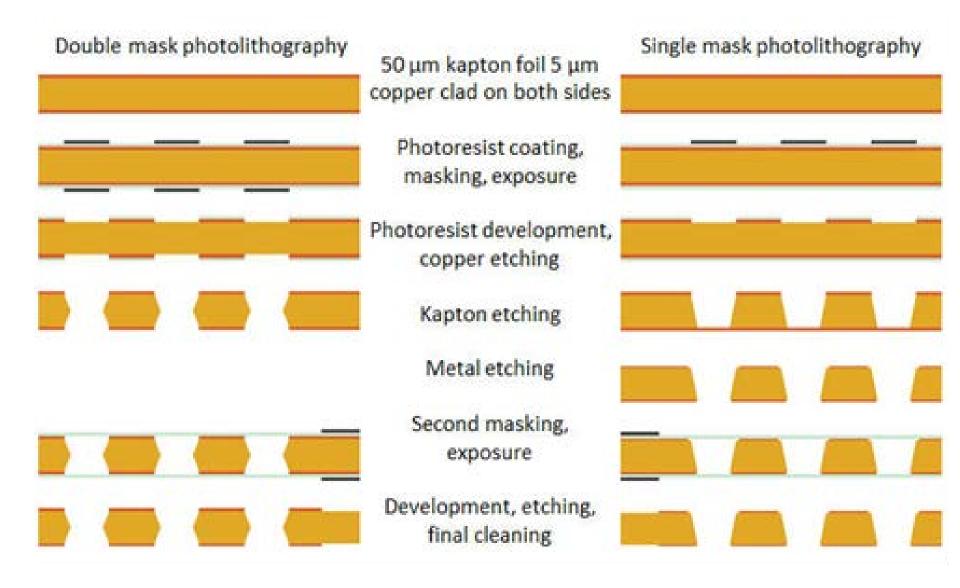
- Typical GEM Foil has 3 layers, two 5μm thick copper foils and one 50μm thick kapton foil in the middle.
- 2. Diameter of the hole is 70  $\mu$ m , and the distance between them is 140  $\mu$ m .
- 3. Apply electric voltages on the two copper layers.
- 4. Electric Field is very strong in the hole area, and weak outside the hole area.



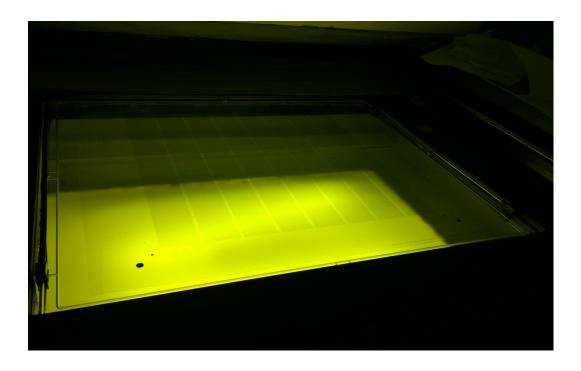
**GEM Foil** 



#### The Procedure of GEM Foil

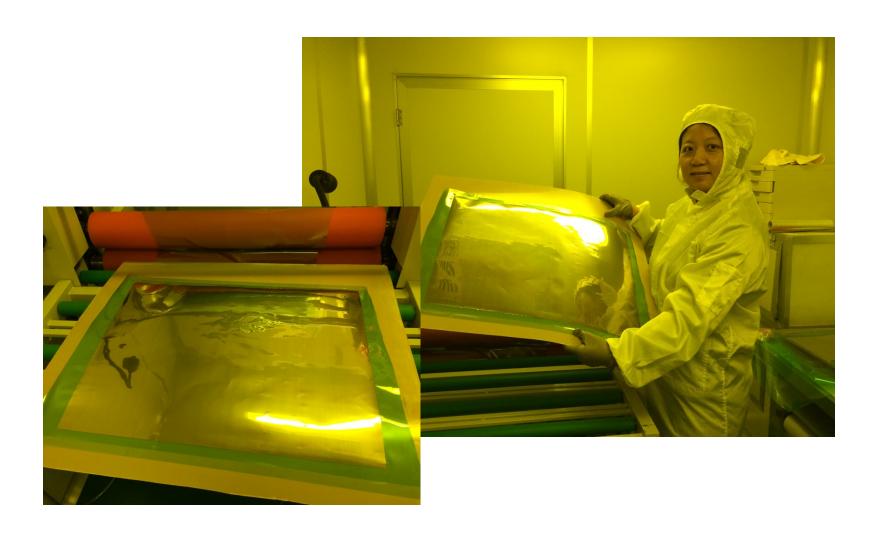


#### **GEM Photo Mask Plate**



The copies of the photo-mask are done by photolithographic techniques. 40cm\*40cm photo mask is produced.

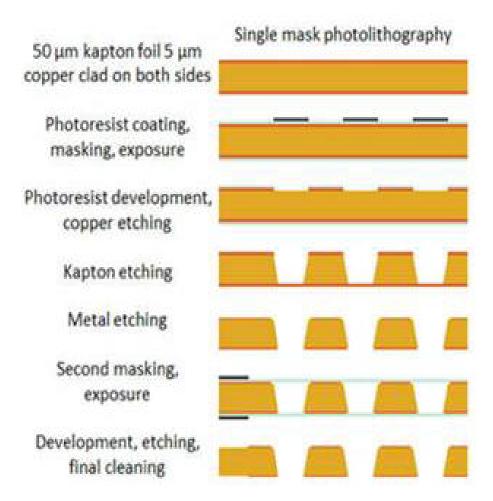
## **Lamination of Dry Film Photoresist**

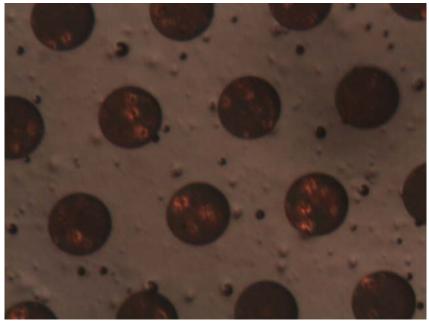


## **Exposure of Dry Film Photoresist**

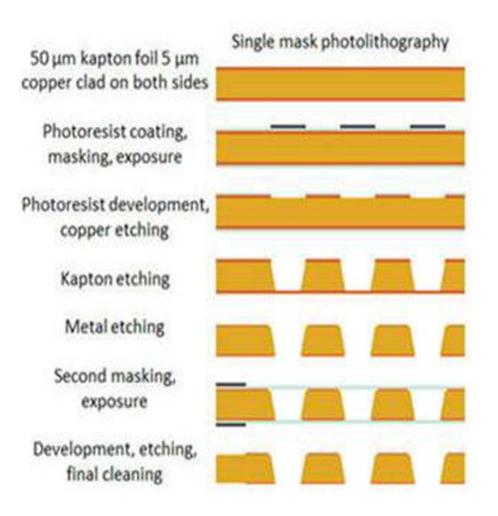


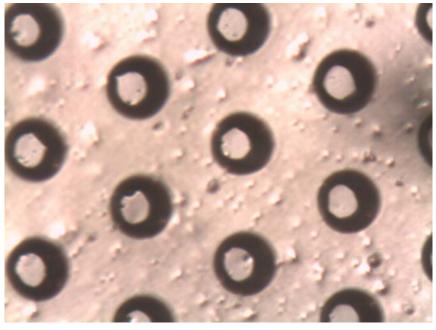
## **After First Copper Etching**



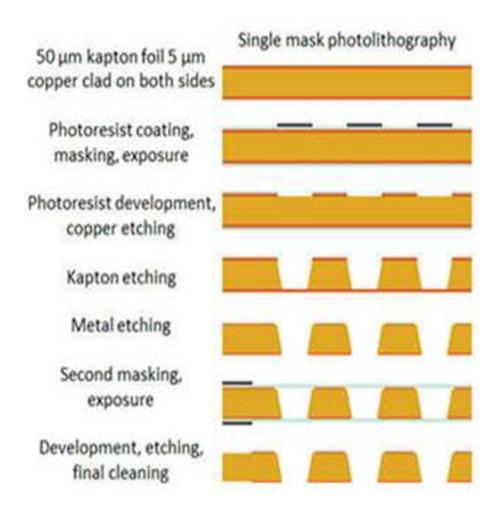


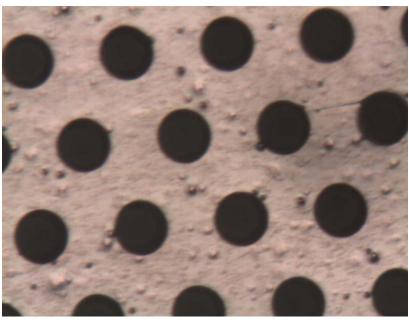
## **After First Kapton Etching**



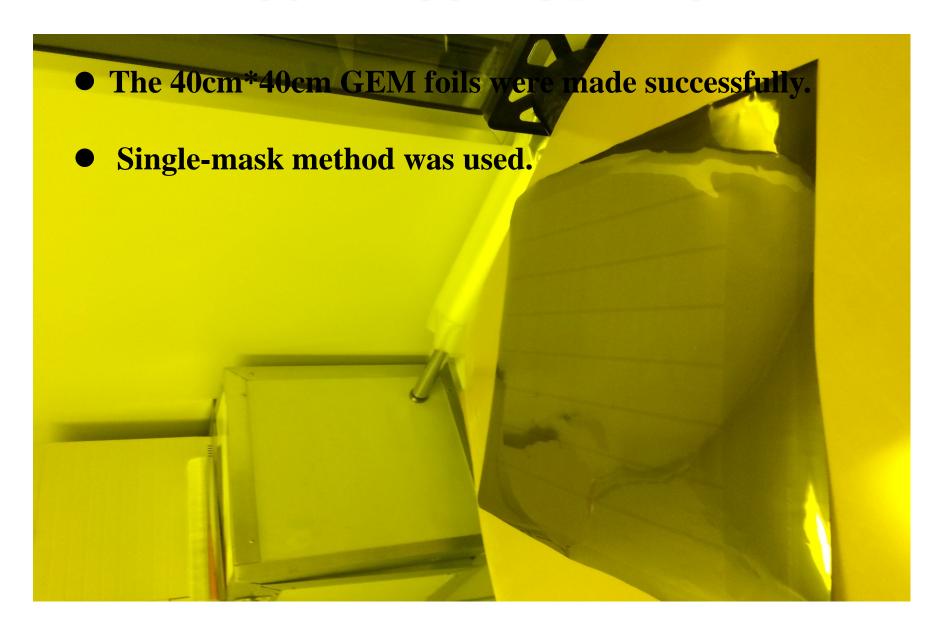


### **After Second Copper Etching**

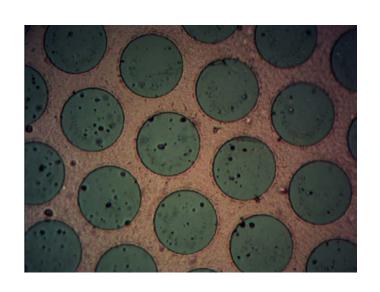


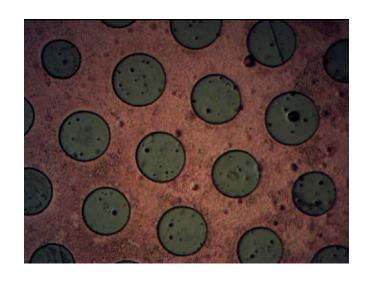


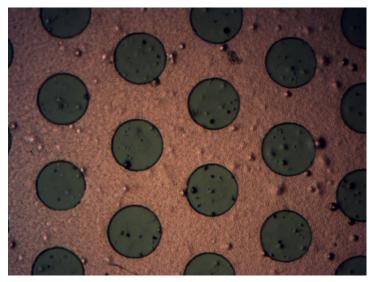
#### 40cm\*40cm GEM Foil



### **New Chemical Reagents**







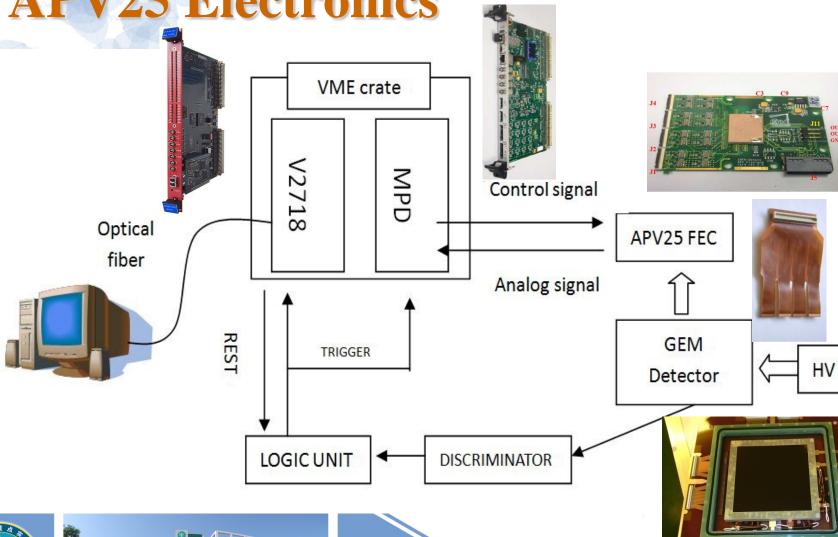
### **Other Developments**





## GEM Test system with 据重点实验室

**APV25 Electronics** 







## $\sigma_{tot}^{2} = \sigma_{GEM}^{2} + c_{1}\sigma_{geometry}^{2}$ When: $\sigma_{geometry} \ll \sigma_{GEM}$

$$\sigma_{tot}^2 \cong \sigma_{GEM}^2$$

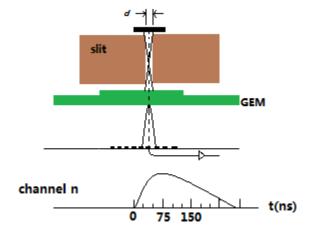
- Slit(um): 20;
- Ar:  $CO_2 = 70\% : 30\%$ ;
- HV: 3600V;
- The distance between strips: 400um;

$$\varepsilon = 19.6\%$$

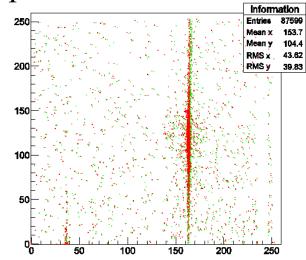




#### **Spatial resolution**



#### Spatial resolution≈76um



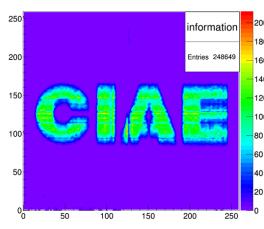
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#### X-ray imaging @ CIAE

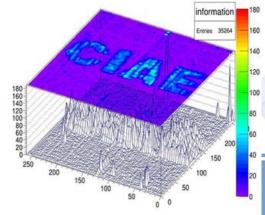




- ●X ray Energy: 8.9KeV;
- •about 1k sample rate
- ●256 channels for each dimension (512 channel in total);
- •4 APV FECs were used (2 for each dimension)

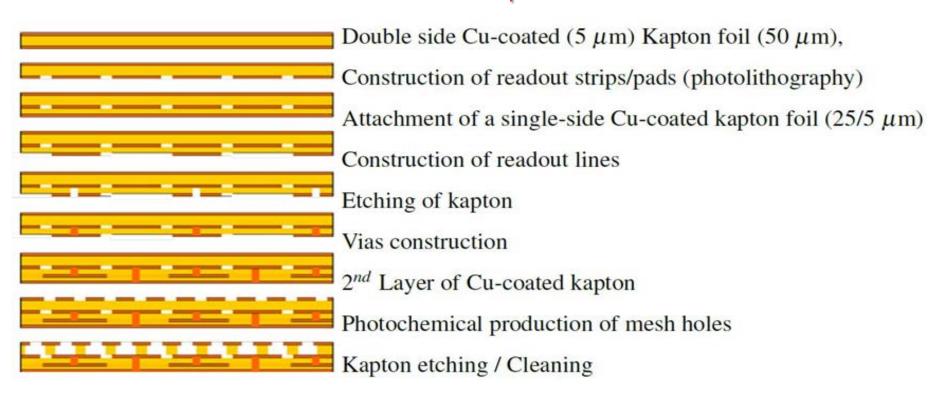






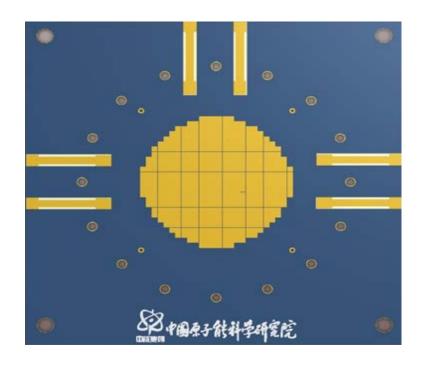
## Microbulk Micromegas Fabrication Process

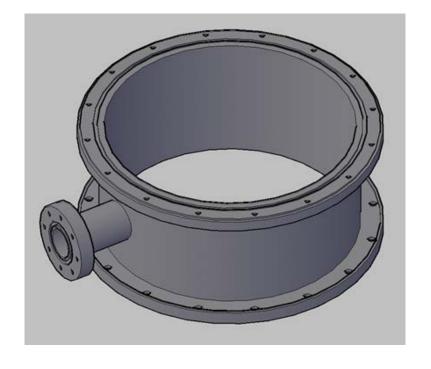
This technology is inspired by the GEM detector fabrication process invented at CERN.



#### **Next Step**

New design of 20cm diameter round MicroBulk MicroMegas Prototype: 0.5cm<sup>2</sup> pad, 512 APV25 electronics





## 总结与展望

- •在过去一年中,利用Single Mask技术研制出40cm\*40cm GEM 膜。
- ·完成GEM探测器APV25电子学测试和成像研究
- •准备进行用自己研发的GEM膜制成GEM探测器并进行测试。降低废品率。如果顺利的话,就可以尝试进行GEM膜小批量生产。
- •利用与GEM膜工艺非常相近的光刻蚀刻技术进行新型微网探测器研制。





# 感谢核探测器与核电子学国家重点实验室开放基金支持!

## Thank You!



